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### 2.8X0.8mm RIGHT ANGLE SMD CHIP LED LAMP

### **Features**

 $\bullet$  Ideal for indication light on hand held products

• Long life and robust package

• Standard Package: 2,000pcs/ Reel

 $\bullet$  MSL (Moisture Sensitivity Level): 3

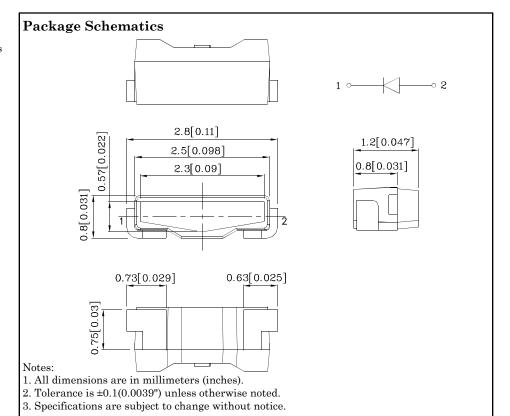
• RoHS compliant







# ATTENTION OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE DEVICES



Absolute Maximum Ratings (T <sub>A</sub> =25°C)		CBD (InGaN)	Unit	
Reverse Voltage	$V_{\mathrm{R}}$	5	V	
Forward Current	$I_{\mathrm{F}}$	30	mA	
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	ifs	150	mA	
Power Dissipation	$P_{D}$	120	mW	
Operating Temperature	$T_{A}$	-40 ~ +85	°C	
Storage Temperature	Tstg	-40 ~ +85		
Electrostatic Discharge Threshold (HBM)	250	V		

Operating Characteristics ( $T_A$ =25°C)		CBD (InGaN)	Unit
Forward Voltage (Typ.) (I <sub>F</sub> =20mA)	$V_{\mathrm{F}}$	3.3	V
Forward Voltage (Max.) (I <sub>F</sub> =20mA)	$V_{\mathrm{F}}$	4	V
Reverse Current (Max.) $(V_R=5V)$	$I_{ m R}$	50	uA
Wavelength of Peak Emission CIE127-2007*(Typ.) $(I_F=20 \text{mA})$	λΡ	460*	nm
Wavelength of Dominant Emission CIE127-2007*(Typ.) $(I_F=20 \text{mA})$	λD	465*	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I <sub>F</sub> =20mA)	$\triangle \lambda$	25	nm
Capacitance (Typ.) (V <sub>F</sub> =0V, f=1MHz)	С	100	pF

Part Number	Emitting Color	Emitting Material	Lens-color	$\begin{array}{c} \text{Luminous Intensity} \\ \text{CIE127-2007*} \\ \text{(I}_{\text{F}}\text{=20mA)} \\ \text{mcd} \end{array}$		Wavelength CIE127-2007* $^{ m nm}$ $^{ m \lambda P}$	Viewing Angle 20 1/2
				min.	typ.		
XZCBD81FS	Blue	InGaN	Water Clear	80*	148*	460*	110°

 $<sup>^*</sup>$ Luminous intensity value and wavelength are in accordance with CIE127-2007 standards.

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### 2.8 X 0.8 mm RIGHT ANGLE SMD CHIP LED LAMP

### **Handling Precautions**

Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although its characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force.

As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED.

As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might lead to damage and premature failure of the LED.

1.Do not directly touch or handle the silicone lens surface. It may damage the internal circuitry.

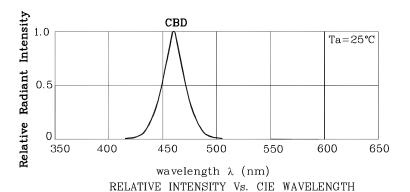


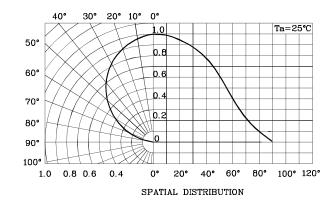
2. As silicone encapsulation is permeable to gases, some corrosive substances such as  $H_2S$  might corrode silver plating of leadframe. Special care should be taken if an LED with silicone encapsulation is to be used near such substances.

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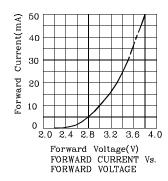
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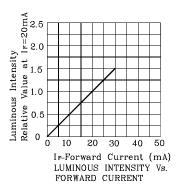


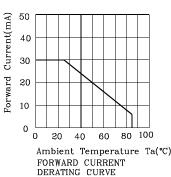


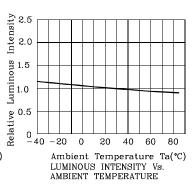


### **♦** CBD



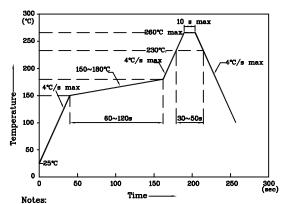






## LED is recommended for reflow soldering and soldering profile is shown below.

Reflow Soldering Profile for SMD Products (Pb-Free Components)

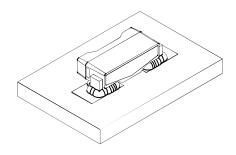


- 1. Maximum soldering temperature should not exceed 260°C
- 2. Recommended reflow temperature: 145°C-260°C
- 3. Do not put stress to the epoxy resin during high temperatures conditions

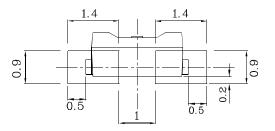




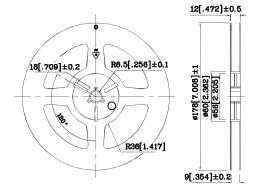
# ❖ The device has a single mounting surface. The device must be mounted according to the specifications.



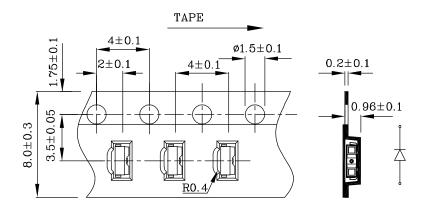
### **♦** Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



### **❖** Reel Dimension



### **❖** Tape Specification (Units:mm)



### Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

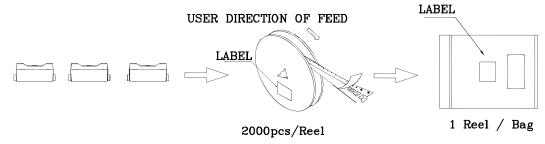
- 1. Wavelength: +/-1nm
- 2. Luminous intensity / luminous flux: +/-15%
- 3. Forward Voltage: +/-0.1V

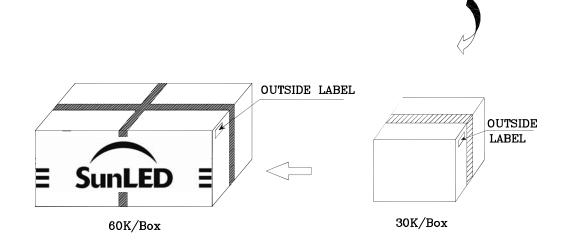
Note: Accuracy may depend on the sorting parameters.

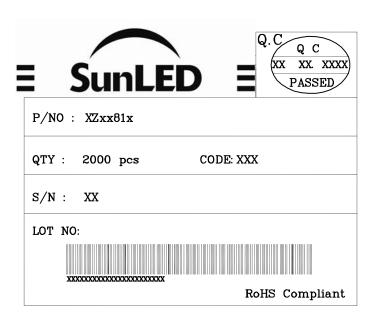




### PACKING & LABEL SPECIFICATIONS







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- $6. \ Additional \ technical \ notes \ are \ available \ at \ \underline{http://www.SunLEDusa.com/TechnicalNotes.asp}$

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